

HD74HCT564, HD74HCT574

Octal D-type Flip-Flops (with 3-state outputs)

REJ03D0670-0200 (Previous ADE-205-560) Rev.2.00 Mar 30, 2006

Description

These devices are positive edge triggered flip-flops. The difference between HD74HCT564 and HD74HCT574 is only that the former has inverting outputs and the latter has noninvertering outputs.

Data at the D inputs, meeting the set-up and hold time requirements, are transferred to the Q or \overline{Q} outputs on positive going transitions of the clock (CK) input. when a high logic level is applied to the output control (OC) input, all outputs go to a high impedance state, regardless of what signals are present at the other inputs and the state of the storage elements.

Features

• LSTTL Output Logic Level Compatibility as well as CMOS Output Compatibility

• High Speed Operation: t_{pd} (D to Q, \overline{Q}) = 15 ns typ ($C_L = 50 \text{ pF}$)

High Output Current: Fanout of 15 LSTTL Loads
 Wide Operating Voltage: V_{CC} = 4.5 to 5.5 V

• Low Input Current: 1 μA max

• Low Quiescent Supply Current: I_{CC} (static) = 4 μ A max (Ta = 25°C)

• Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)	
HD74HCT564P	DILP-20 pin	PRDP0020AC-B	P		
HD74HCT574P	DILP-20 PIII	(DP-20NEV)			
HD74HCT564FPEL	COD 20 pin / IFITA)	PRSP0020DD-B	FP	FL (2.000 mag/real)	
HD74HCT574FPEL	SOP-20 pin (JEITA)	(FP-20DAV)		EL (2,000 pcs/reel)	
HD74HCT564RPEL	COD 20 pin (JEDEC)	PRSP0020DC-A	RP	FL (4.000 pag/ragl)	
HD74HCT574RPEL	SOP-20 pin (JEDEC)	(FP-20DBV)	Kr	EL (1,000 pcs/reel)	

Note: Please consult the sales office for the above package availability.

Function Table

	Inputs	Outputs			
Output Control	Clock	Data	HD74HCT564	HD74HCT574	
L		Н	L	Н	
L		L	Н	L	
L	L	X	Q_0	Q_0	
Н	X	X	Z	Z	

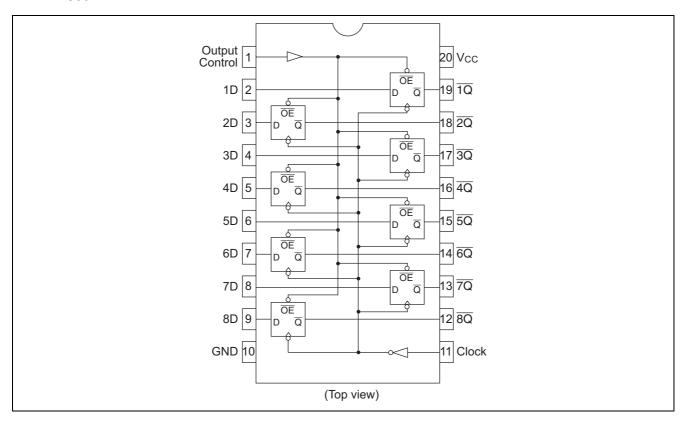
Q₀: level of Q before the indicated Steady-sate input conditions were established.

 \overline{Q}_0 : complement of Q_0 or level of \overline{Q} before the indicated Steady-state input Conditions were established.

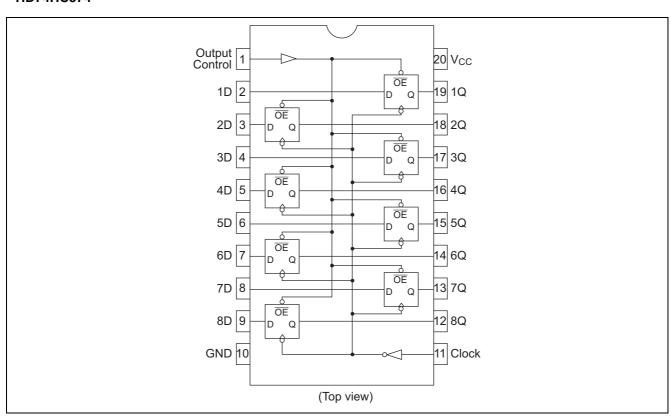


Pin Arrangement

HD74HC564

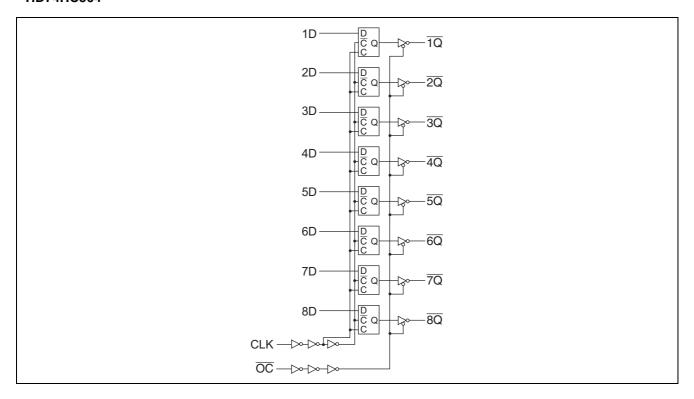


HD74HC574

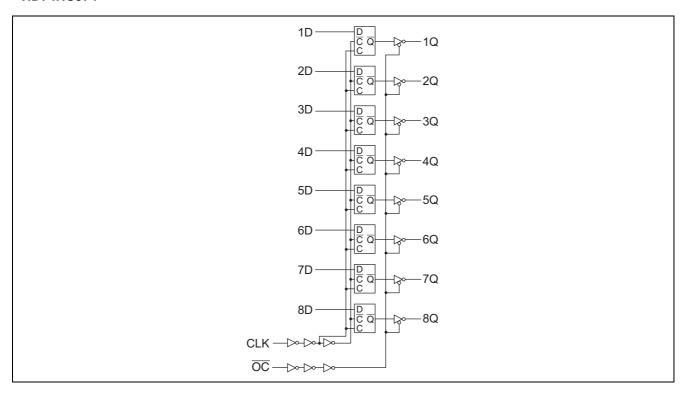


Logic Diagram

HD74HC564



HD74HC574



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit
Supply voltage range	V _{CC}	-0.5 to 7.0	V
Input / Output voltage	V _{IN} , V _{OUT}	-0.5 to V_{CC} +0.5	V
Input / Output diode current	I _{IK} , I _{OK}	±20	mA
Output current	Io	±35	mA
V _{CC} , GND current	I _{CC} or I _{GND}	±75	mA
Power dissipation	P _T	500	mW
Storage temperature	Tstg	-65 to +150	°C

Note: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

Recommended Operating Conditions

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V _{CC}	4.5 to 5.5	V	
Input / Output voltage	V_{IN}, V_{OUT}	0 to V _{CC}	V	
Operating temperature	Та	-40 to 85	°C	
Input rise / fall time*1	t _r , t _f	0 to 500	ns	V _{CC} = 4.5 V

Notes: 1. This item guarantees maximum limit when one input switches. Waveform: Refer to test circuit of switching characteristics.

Electrical Characteristics

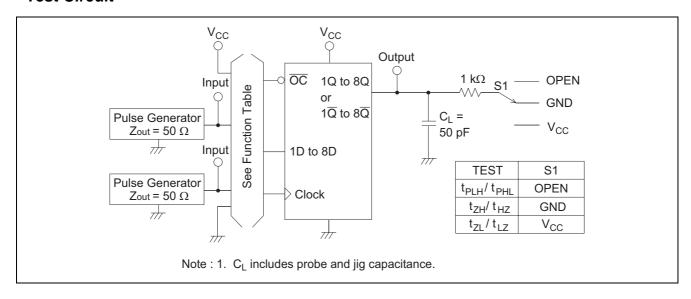
Item	Symbol	Symbol	Symbol	Symbol	Symbol	Symbol	V _{CC} (V)	Т	a = 25°	С	Ta = -40	to+85°C	Unit	Test Conditions	
item	Symbol	VCC (V)	Min	Тур	Max	Min	Max	Oilit	rest Conditions						
Input voltage	V _{IH}	4.5 to 5.5	2.0	_	_	2.0	_	V							
	V _{IL}	4.5 to 5.5	_	_	8.0	_	0.8	V							
Output voltage	V _{OH}	4.5	4.4	_	_	4.4	_	V	Vin = V_{IH} or V_{IL} $I_{OH} = -20 \mu A$						
		4.5	4.18	_	_	4.13	_		$I_{OH} = -6 \text{ mA}$						
	V _{OL}	4.5	_	_	0.1	_	0.1	V	Vin = V_{IH} or V_{IL} I_{OL} = 20 μ A						
		4.5	_	_	0.26	_	0.33		$I_{OL} = 6 \text{ mA}$						
Off-state output	loz	5.5	_	_	±0.5	_	±5.0	μΑ	$Vin = V_{IH} \text{ or } V_{IL},$ $Vout = V_{CC} \text{ or GND}$						
current															
Input current	lin	5.5	_	_	±0.1	_	±1.0	μΑ	$Vin = V_{CC}$ or GND						
Quiescent current	Icc	5.5	_	_	4.0	_	40	μΑ	Vin = V_{CC} or GND, lout = 0μ						

Switching Characteristics

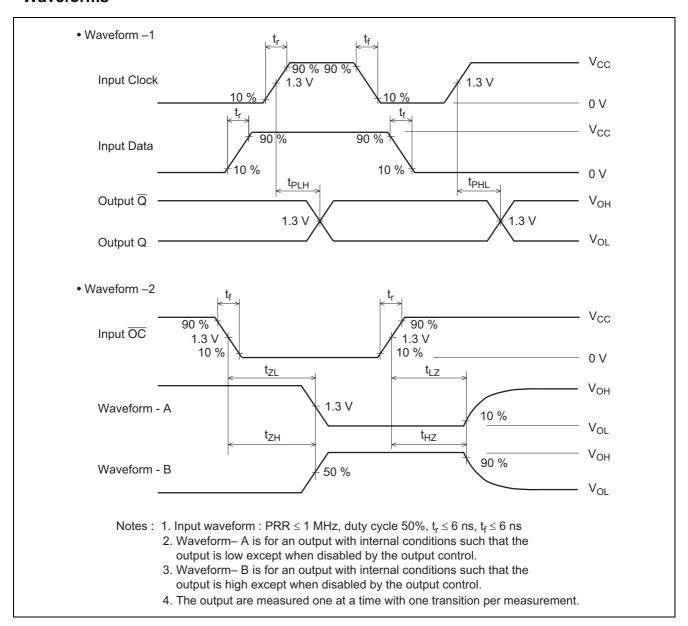
 $(C_L = 50 \text{ pF, Input } t_r = t_f = 6 \text{ ns})$

Item	Symbol	V _{CC} (V)	Ta = 25°C		Ta = -40 to +85°C		Unit	Test Conditions	
item			Min	Тур	Max	Min	Max	Onit	rest Conditions
Maximum clock frequency	f _{max}	4.5		_	30	_	24	ns	
Propagation delay time	t _{PLH}	4.5	_	14	31	_	39	ns	
	t _{PHL}	4.5	1	15	31	_	39		
Output enable time	t _{ZL}	4.5	-	16	30	_	38	ns	
	t _{zH}	4.5	_	16	30	_	38		
Output disable time	t _{LZ}	4.5	_	15	30	_	38	ns	
	t _{HZ}	4.5	_	18	30	_	38		
Setup time	t _{su}	4.5	20	3	_	25	_	ns	
Hold time	t _h	4.5	5	-2	_	5	_	ns	
Pulse width	t _w	4.5	16	7	_	20	_	ns	
Output rise/fall time	t _{TLH}	4.5	_	4	12	_	15	ns	
	t _{THL}	4.5	_	4	12	_	15		
Input capacitance	Cin	_	_	5	10	_	10	pF	

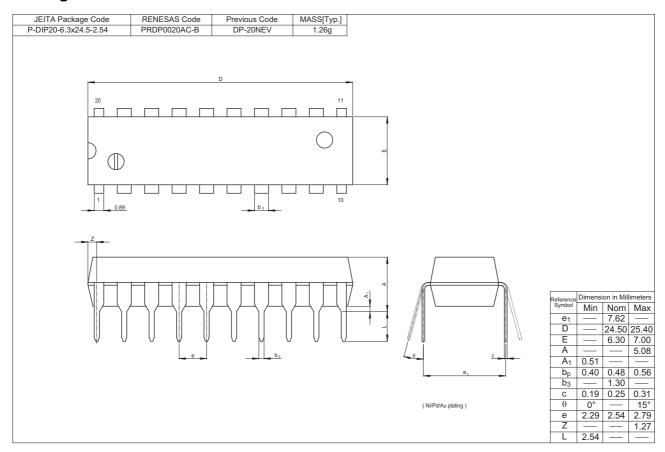
Test Circuit

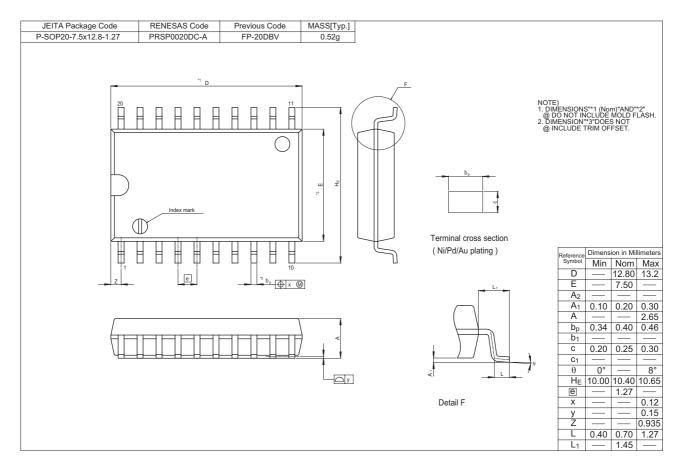


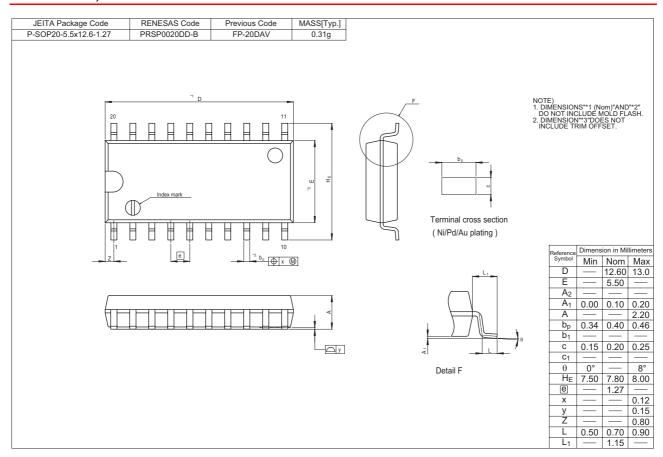
Waveforms



Package Dimensions







Renesas Technology Corp. Sales Strategic Planning Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan

Keep safety first in your circuit designs!

1. Renesas Technology Corp. puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage.

Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of nonflammable material or (iii) prevention against any malfunction or mishap.

Notes regarding these materials

1. These materials are intended as a reference to assist our customers in the selection of the Renesas Technology Corp. product best suited to the customer's application; they do not convey any license under any intellectual property rights, or any other rights, belonging to Renesas Technology Corp. or a third party.

2. Renesas Technology Corp. assumes no responsibility for any damage, or infringement of any third-party's rights, originating in the use of any product data, diagrams, charts, programs, algorithms, or circuit application examples contained in these materials, including product data, diagrams, charts, programs and algorithms represents information on products at the time of publication of these materials, and are subject to change by Renesas Technology Corp. without notice due to product improvements or other reasons. It is therefore recommended that customers contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor for the latest product information before purchasing a product listed herein.

The information described here may contain technical inaccuracies or typographical errors.

Renesas Technology Corp. assumes no responsibility for any damage, liability, or other loss rising from these inaccuracies or errors.

Please also pay attention to information published by Renesas Technology Corp. by various means, including the Renesas Technology Corp. Semiconductor home page (http://www.renesas.com).

4. When using any or all of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to

- However the state of the information contained in these materials, including product data, diagrams, charts, programs, and algorithms, please be sure to evaluate all information as a total system before making a final decision on the applicability of the information and products. Renesas Technology Corp. assumes no responsibility for any damage, liability or other loss resoluting from the information contained herein.

 5. Renesas Technology Corp. semiconductors are not designed or manufactured for use in a device or system that is used under circumstances in which human life is potentially at stake. Please contact Renesas Technology Corp. or an authorized Renesas Technology Corp. product distributor when considering the use of a product contained herein for any specific purposes, such as apparatus or systems for transportation, vehicular, medical, aerospace, nuclear, or undersea repeater use.
- use.

 6. The prior written approval of Renesas Technology Corp. is necessary to reprint or reproduce in whole or in part these materials.

 7. If these products or technologies are subject to the Japanese export control restrictions, they must be exported under a license from the Japanese government and cannot be imported into a country other than the approved destination.

 Any diversion or reexport contrary to the export control laws and regulations of Japan and/or the country of destination is prohibited.

 8. Please contact Renesas Technology Corp. for further details on these materials or the products contained therein.



RENESAS SALES OFFICES

http://www.renesas.com

Refer to "http://www.renesas.com/en/network" for the latest and detailed information.

Renesas Technology America, Inc. 450 Holger Way, San Jose, CA 95134-1368, U.S.A Tel: <1> (408) 382-7500, Fax: <1> (408) 382-7501

Renesas Technology Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K.
Tel: <44> (1628) 585-100, Fax: <44> (1628) 585-900

Renesas Technology (Shanghai) Co., Ltd.
Unit 204, 205, AZIACenter, No.1233 Lujiazui Ring Rd, Pudong District, Shanghai, China 200120 Tel: <86> (21) 5877-1818, Fax: <86> (21) 6887-7898

Renesas Technology Hong Kong Ltd.
7th Floor, North Tower, World Finance Centre, Harbour City, 1 Canton Road, Tsimshatsui, Kowloon, Hong Kong Tel: <852> 2265-6688, Fax: <852> 2730-6071

Renesas Technology Taiwan Co., Ltd.10th Floor, No.99, Fushing North Road, Taipei, Taiwan Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

Renesas Technology Singapore Pte. Ltd.
1 Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632 Tel: <65> 6213-0200, Fax: <65> 6278-8001

Renesas Technology Korea Co., Ltd. Kukje Center Bldg. 18th Fl., 191, 2-ka, Hangang-ro, Yongsan-ku, Seoul 140-702, Korea Tel: <82> (2) 796-3115, Fax: <82> (2) 796-2145

Renesas Technology Malaysia Sdn. Bhd
Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No.18, Jalan Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia Tel: <603> 7955-9390, Fax: <603> 7955-9510